

Features

- Low start-up current 64 μ A (Typ)
- Low running current 2 mA (Typ)
- Low power light load mode
- Low power standby when OV is activated
- Extended commercial operating temperature range: 0 to 105°C
- On-board fixed frequency oscillator 100 kHz (Typ)
- Frequency randomizer to reduce EMC emissions
- Dedicated OV shutdown pin
- On-board voltage ramp compensation
- On-board current sensing filtering
- Optional primary side regulation

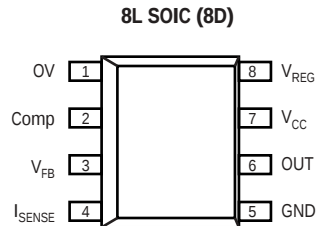
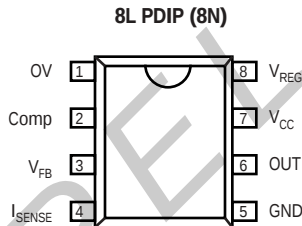
Description

The AS998/AS998A is an IC intended for use as a PWM controller for switch mode power supplies. The device is particularly suited as a primary side controller for adapter, printer, peripheral, mobile chargers and desktop auxiliary power supplies. The AS998/AS998A is manufactured in BICMOS technology and exhibits very low start-up and operating power. This allows the device to be suitable in applications where stringent standby or Blue Angel criteria are required.

Many of the external functions associated with PWM controllers have been integrated into the AS998/AS998A allowing the external component count to be significantly reduced. Features such as fixed internal oscillator, internal ramp compensation and current filters all reduce the external support components.

The AS998/AS998A has a typical output rise and fall time of 250/210 ns.

Pin Configuration – Top View



Ordering Information

Circuit Type: AS998/A B 8D N

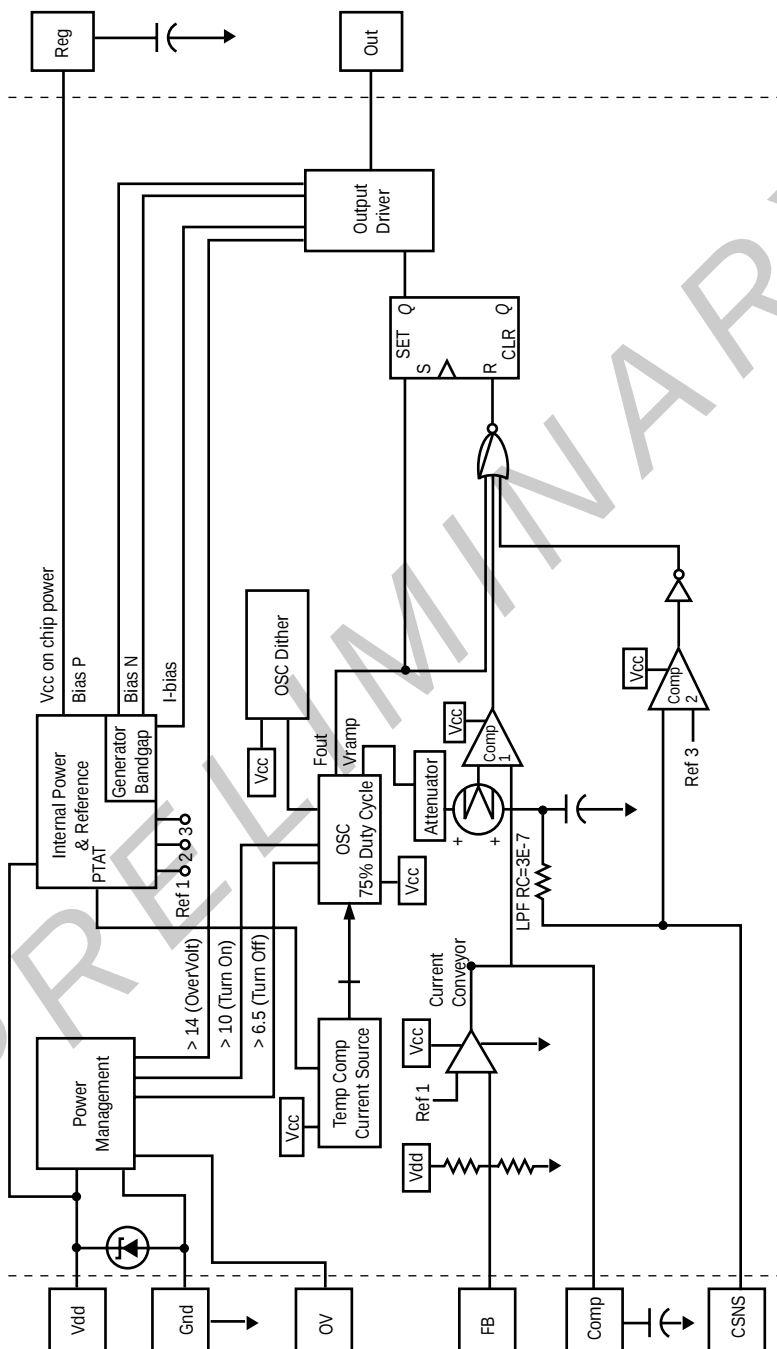
PWM Controller (Models AS998 & AS998A)

Temperature Range: B = 0°C to 105°C

Packaging Option:
T = Tubes
N = Tape and Reel (13" Reel Dia.)

Package Type:
8D = 8 Pin, Plastic SOIC
8N = 8 Pin, Plastic DIP

Functional Block Diagram



Pin Function Description

Pin Number	Function	Description
1	OV	Overvoltage pin. The OV input/output function is implemented by an on-chip latch. This pin is driven to the Reg voltage if the on-chip circuitry senses a VDD level greater than the OV threshold (VDDov). This error condition stops the part from generating any more output pulses until VDD has been reduced to the VDDul level and then raised as in a normal power-on sequence. Alternatively, the OV error condition can be cleared by forcing the OV pin to near ground. The output is immediately enabled following an OV clear function. The OV error condition can also be generated externally by temporarily forcing the OV pin to a voltage greater than the VOV threshold. This will force the part to latch an
OV condi-		described.
2	COMP	Compensation pin. This pin is the output of the error amplifier and can also be used as an input for an optocoupled control signal to the PWM comparator. Generally this pin is connected to a feedback network to FB. If an optocoupler feedback is used, COMP connects to the collector of the common emitter optocoupler, generally with a pull-up resistor to VDD or Reg.
3	FB	Feedback pin. Inverting input to the error amplifier. This pin is tied to an internal default divider which will tend to regulate VDD at a nominal 11V.
4	CSNS	Current sense input. The signal on this pin is fed via a low pass filter to the PWM com-parator. Superimposed on the input to the PWM is a slope compensation ramp derived from the main oscillator. In addition to the above, the current sense signal is connected directly to an over-current comparator that detects an overload condition and immediately terminates the gate drive pulse with a minimum propagation delay.
5	GND	Circuit common ground.
6	OUT	Gate drive output. The current source and sink capability of the output buffer is tailored to minimize EMI. When the IC is not running, this pin is held low so a pull down resistor on the FET gate is not required.
7	VDD	Positive supply voltage. An on-board shunt regulator allows this IC to be powered via a simple resistor from a widely varying bias supply. The ICs power management block keeps the part in startup current mode while VDD is ramping up until the part turns on at the UVLhigh threshold. The IC then draws the specified supply current while operating unless VDD drops below the UVLow threshold. If VDD drops below UVLow, then the part will return to startup current mode.
8	REG	Voltage regulator. Decoupling pin as required for internal low voltage supply. This pin may be used to source 1mA for the control optocoupler.

Electrical Characteristics

Electrical Characteristics are guaranteed over full junction temperature range (0 to 105°C). Ambient temperature must be derated based on power dissipation and package thermal characteristics. Unless otherwise specified, the conditions of test are $V_{DD} = 12\text{ V}$; $OV = 0\text{ V}$, $CSNS = 0\text{ V}$. $C_{load} = 1800\text{ pF}$, $C_{reg} = 100\text{ nF}$ (AVDD to GND). To start chip, V_{dd} must be raised above UVLhigh.

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Startup Current	I_{DDO}	UVL _{HIGH} Threshold		64	100	μA
Supply Current	I_{DD}	No Load	1	2	4	mA
Startup Threshold	UVL _{HIGH}	AS998	9	10	11	V
		AS998A	9.5	10	10.5	V
UVL off Threshold	UVL _{LOW}		7.6	8	8.4	V
Bias Current at POS	V_{CLAMP}	$I_{DD} = 10\text{ mA}$ No Load	13	14	14.7	V
Int Regulator Voltage	V_{REG}	$I_{REG} = 1\text{ mA}$	5.5	6.25	7.0	V

Oscillator

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Mean Period	T_{OSC}	$8.4\text{ V} < V_{DD} < 13.3\text{ V}$; 15 cycle avg. - AS998	7.3	9.3	11.7	μs
		$8.4\text{ V} < V_{DD} < 13.3\text{ V}$; 15 cycle avg. - AS998A	8.1	9.3	10.7	μs
Modulation Repetition Rate	T_{REP}			15		cycles
Peak-to-Peak Modulation	T_{DEV}	Peak-to-Peak change in period	13.7	16.5	23	%
Max. Duty Cycle	D_{MAX}		70	75	78	%

Error Amplifier

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
FB Divider R	RFB			100		$\text{k}\Omega$
V_{DD} Regulation Point	V_{DDREG}		11.4	12	12.6	V
FB Threshold	V_{REF}	COMP = FB, $V_{DD} = 12\text{ V}$	2.37	2.5	2.62	V
Gain (DC)	AV_{OL}	No load on COMP		85		dB
Gain-Bandwidth Product	GBP	No load on COMP		10		MHz
COMP Output High	V_{COMPH}	FB = 2V	4.5			V
COMP Output Low	V_{COMPL}	FB = 3V		100	250	mV
COMP Source Current	I_{COMPH}	COMP = 3V, FB = 2V	25	50	100	μA
COMP Sink Current	I_{COMPL}	COMP = 1V, FB = 3V	25	300	500	μA

Current Sense Comparator

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Scaling of COMP		to CSNS input		0.4		
AC Input Impedance	R_{CSAC}	$F_{in} \geq F_{CO}$		100		$\text{k}\Omega$
Input Filter	F_{CS}	Time Constant		320		ns
Prop. Delay to Output	t_{pd1}			700		ns

Electrical Characteristics (cont.)**Over Current Comparator**

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Comparator Threshold	V_{CSTH}	COMP = 1V, FB = 3V		1.25		V
Propagation Delay to Output	tpd2	FB = 2, Vcs step to 1.65V, from 50% point on CSNS input to 90% point on output H to L transistion		100	150	ns

Over Voltage Input

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
OV V_{DD} Threshold	V_{DDOV}	Forcing V_{DD} pin	13	14	14.7	V
OV Threshold	V_{OV}	Forcing OV pin		3.5		V
OV Latch State Low	OV_{RN}	OV = Reg - 1V, Equiv. R to Reg	4	8	16	k Ω
OV Latch State High	OV_{RP}	OV = 1V, Equiv. R to Gnd	4	8	16	k Ω
OV Hi Impedance Pull-up	OV_{HI}	OV = 1V, $I_{DD} = 10mA$		0.3	1	μA
OV Unlatch Threshold	V_{DDUL}	V_{DD} dropped until latch fails	4.75	5	5.25	V

Output

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Max. "Off State" Voltage	V_{OFF}	$I_{OUT} = 100\mu A$			1.7	V
Output Rise Time	tr	T = 25°C, 10% - 90%	170	250	290	ns
Output Fall Time	tf	T = 25°C, 10% - 90%	140	210	240	ns